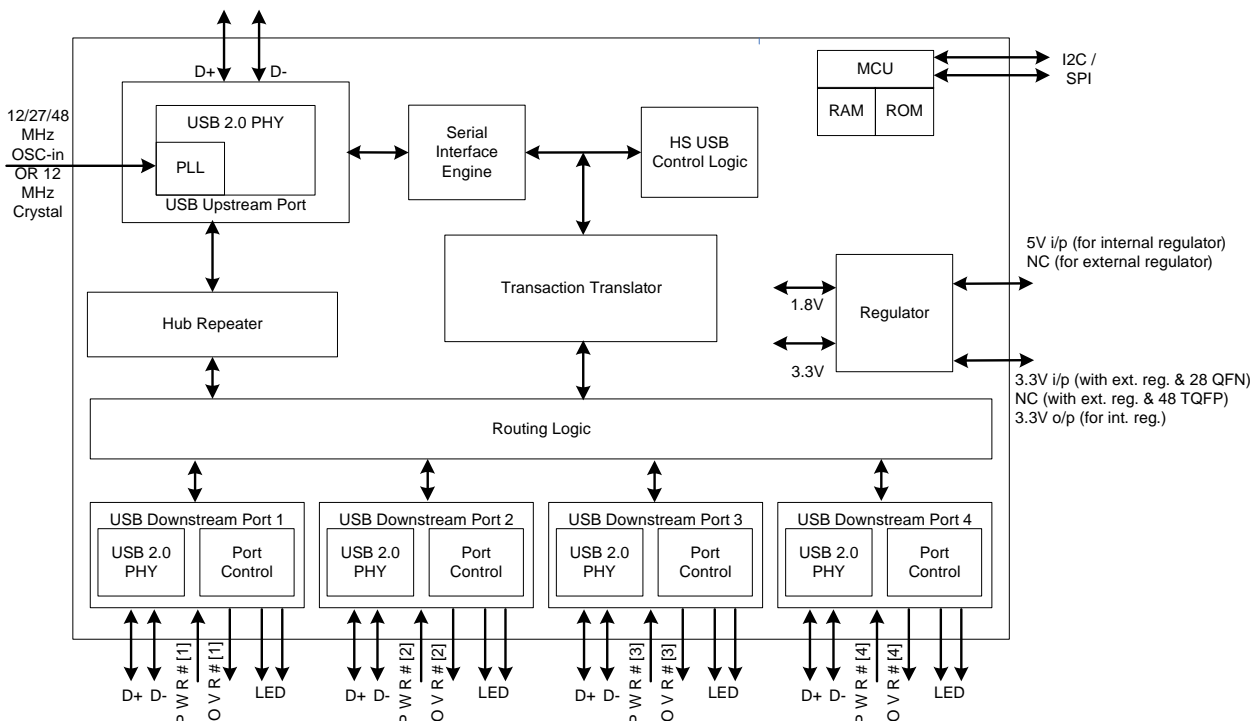


HX2VL™ Very Low Power USB 2.0 Hub Controller

Features

- High performance, low-power USB 2.0 Hub, optimized for low cost designs with minimum Bill-of-material
- USB 2.0 hub controller
 - Compliant with USB 2.0 specification
 - Up to four downstream ports support
 - Downstream ports are backward compatible with FS,LS
 - Single transaction translator (TT) for low cost
- Very low power consumption
 - Supports bus-powered and self-powered modes
 - Auto switching between bus-powered and self-powered
 - Single MCU with 2 K ROM and 64 byte RAM
 - Lowest power consumption
- Highly integrated solution for reduced BOM cost
 - Internal regulator – single power supply 5 V required
 - Provision of connecting 3.3 V with external regulator
 - Integrated upstream pull-up resistor
 - Integrated pull-down resistors for all downstream ports
 - Integrated upstream/downstream termination resistors
- Integrated port status indicator control
- 12 MHz +/- 500 ppm external crystal with drive level 600 μW (integrated PLL) clock input with optional 27/48 MHz oscillator clock input
- Internal power failure detection for ESD recovery
- Downstream port management
 - Support individual and ganged mode power management
 - Overcurrent detection within 8 mS
 - Two port status indicators per downstream port
 - Slew rate control for EMI management
- Maximum configurability
 - VID and PID are configurable through external EEPROM
 - Number of ports, removable/non-removable ports are configurable through EEPROM and I/O pin configuration
 - I/O pins can configure gang/individual mode power switching, reference clock source and polarity of power switch enable pin
 - Configuration options also available through mask ROM
- Available in space saving 48-pin (7 × 7 mm) TQFP and 28-pin (5 × 5 mm) QFN packages
- Supports 0 °C to 70 °C temperature range

Block Diagram – CY7C65632



Contents

Introduction	3	Features Supported in 48-pin and 28-pin Packages	12
USB Serial Interface Engine	3	Power Switch Enable Pin Polarity	12
HS USB Control Logic	3	Port Number Configuration	12
Hub Repeater	3	Non Removable Ports Configuration	13
MCU	3	Reference Clock Configuration	13
Transaction Translator	3	Electrical Characteristics	14
Port Control	3	Absolute Maximum Ratings	14
Applications	3	Operating Conditions	14
Functional Overview	4	AC Electrical Characteristics	15
System Initialization	4	Ordering Information	16
Upstream Port	4	Ordering Code Definitions	16
Downstream Ports	4	Package Diagrams	17
Power Switching	4	Acronyms	18
Pin Configuration CY7C65632 – 48 TQFP	6	Document Conventions	18
Pin Description for 48-Pin Package	8	Units of Measure	18
Pin Description for 28-Pin Package	10	Document History Page	19
EEPROM Configuration Options	11	Sales, Solutions, and Legal Information	20
Pin Configuration Options	12	Worldwide Sales and Design Support	20
Power-on Reset	12	Products	20
Gang/Individual Power Switching Mode	12	PSoC Solutions	20

Introduction

HX2VL™ is Cypress's next generation family of high performance, very low power USB 2.0 hub controllers. HX2VL has integrated upstream and downstream transceivers; a USB Serial Interface Engine (SIE); USB Hub Control and Repeater logic; and Transaction Translator (TT) logic. Cypress has also integrated external components such as voltage regulator and pull-up/pull-down resistors, reducing the overall bill of materials required to implement a USB hub system.

The CY7C65632 is a part of the HX2VL portfolio. This device option is for ultra low power but high performance applications that require up to four downstream ports. All downstream ports share a single transaction translator. The CY7C65632 is available in 48 pin TQFP and 28 pin QFN package options.

All device options are supported by Cypress's world class reference design kits, which include board schematics, bill of materials, Gerber files, Orcad files, and thorough design documentation.

HX2VL Architecture

The logic block diagram on Page 1 shows the HX2VL single TT hub architecture.

USB Serial Interface Engine

The Serial Interface Engine (SIE) allows HX2VL to communicate with the USB host. The SIE handles the following USB activities independently of the Hub Control Block.

- Bit stuffing and unstuffing
- Checksum generation and checking
- TOKEN type identification
- Address checking.

HS USB Control Logic

'Hub Control' block co-ordinates enumeration, suspend and resume. It generates status and control signals for host access to the hub. It also includes the frame timer that synchronizes the hub to the host. It has status/control registers which function as the interface to the firmware in the MCU.

Hub Repeater

The Hub Repeater manages the connectivity between upstream and downstream facing ports that are operating at the same speed. It supports full or low speed connectivity and high speed connectivity. According to the USB 2.0 specification, the HUB Repeater provides the following functions:

- Sets up and tears down connectivity on packet boundaries
- Ensures orderly entry into and out of 'Suspend' state, including proper handling of remote wakeups.

MCU

HX2VL has MCU with 2 K ROM and 64 byte RAM. The MCU operates with a 12 MHz clock to decode USB commands from host and respond to the host. It can also handle GPIO settings to provide higher flexibility to the customers and control the read interface to the EEPROM which has extended configuration options. The MCU is programmable while manufacturing in the factory as per customer needs.

Transaction Translator

The Transaction Translator translates data from one speed to another. A TT takes high speed split transactions and translates them to full or low speed transactions when the hub is operating at high speed (the upstream port is connected to a high speed host controller) and has full or low speed devices attached. The operating speed of a device attached on a downstream port determines whether the routing logic connects a port to the TT or to hub repeater. When the upstream host and downstream device are functioning at different speeds, the data is routed through the TT. In all other cases, the data is routed through the repeater. For example, If a full or low speed device is connected to the high speed host upstream through the hub, then the data transfer route includes TT. If a high speed device is connected to the high speed host upstream through the hub, the transfer route includes the repeater. When the hub is connected to a full speed host controller upstream, then high speed peripheral does not operate at its full capability. These devices only work at full speed. Full and low speed devices connected to this hub operate at their normal speed.

Port Control

The downstream 'Port Control' block handles the connect/disconnect and over current detection as well as the power enable and LED control. It also generates the control signals for the downstream transceivers.

Applications

Typical applications for the HX2VL device family are:

- Docking stations
- Standalone hubs
- Monitor hubs
- Multi-function printers
- Digital televisions
- Advanced port replicators
- Keyboard hubs
- Gaming consoles

Functional Overview

The Cypress CY7C65632 USB 2.0 Hubs are low power hub solutions for USB which provide maximum transfer efficiency. The CY7C65632 USB 2.0 Hubs integrate 1.5 kohm upstream pull-up resistors for full speed operation and all downstream 15 kohm pull-down resistors and series termination resistors on all upstream and downstream D+ and D- pins. This results in optimization of system costs by providing built-in support for the USB 2.0 specification.

System Initialization

On power up, CY7C65632 has an option to enumerate from the default settings in the mask ROM or from reading an external EEPROM for configuration information. At the most basic level, this EEPROM has the Vendor ID (VID) and the Product ID (PID), for the customer's application. For more specialized applications, other configuration options can be specified. See [EEPROM Configuration Options](#) for more details. CY7C65632 verifies the checksum before loading the EEPROM contents as the descriptors.

Enumeration

The device checks if VBUSPOWER (connected to up-stream V_{BUS}) is high, CY7C65632 enables the pull-up resistor on D+ to indicate its presence to the upstream hub, after which a USB Bus Reset is expected. After a USB Bus Reset, CY7C65632 is in an unaddressed, unconfigured state (configuration value set to '0'). During the enumeration process, the host sets the hub's address and configuration. After the hub is configured, the full hub functionality is available.

Upstream Port

The upstream port includes the transmitter and the receiver state machine. The transmitter and receiver operate in high speed and full speed depending on the current hub configuration. The transmitter state machine monitors the upstream facing port while the Hub Repeater has connectivity in the upstream direction. This machine prevents babble and disconnect events on the downstream facing ports of this hub from propagating and causing the hub to be disabled or disconnected by the hub to which it is attached.

Downstream Ports

The CY7C65632 supports a maximum of four downstream ports, each of which may be marked as usable or removable in the EEPROM configuration, see [EEPROM Configuration Options](#). Additionally, number of downstream ports can also be configured by pin strapping, see [Pin Configuration Options](#).

Downstream D+ and D- pull-down resistors are incorporated in CY7C65632 for each port. Before the hubs are configured, the ports are driven SE0 (Single Ended Zero, where both D+ and D- are driven low) and are set to the unpowered state. When the hub is configured, the ports are not driven and the host may power the ports by sending a SetPortPower command for each port. After a port is powered, any connect or disconnect event is detected by the hub. Any change in the port state is reported by the hubs back to the host through the Status Change Endpoint (endpoint 1). On receipt of SetPortReset request for a port with a device connected, the hub does as follows:

- Performs a USB Reset on the corresponding port
- Puts the port in an enabled state
- Enables babble detection after the port is enabled.

Babble consists of a non idle condition on the port after EOF2. If babble is detected on an enabled port, that port is disabled. A ClearPortEnable request from the host also disables the specified port.

Downstream ports can be individually suspended by the host with the SetPortSuspend request. If the hub is not suspended, a remote wakeup event on that port is reflected to the host through a port change indication in the Hub Status Change Endpoint. If the hub is suspended, a remote wakeup event on this port is forwarded to the host. The host may resume the port by sending a ClearPortSuspend command.

Power Switching

The CY7C65632 includes interface signals for external port power switches. Both ganged and individual (per-port) configurations are supported by pin strapping, see [Pin Configuration Options](#).

After enumerating, the host may power each port by sending a SetPortPower request for that port. Power switching and overcurrent detection are managed using respective control signals (PWR#[n] and OVR#[n]) which are connected to an external power switch device. Both High/Low enabled power switches are supported and the polarity is configured through GPIO setting, see [Pin Configuration Options](#).

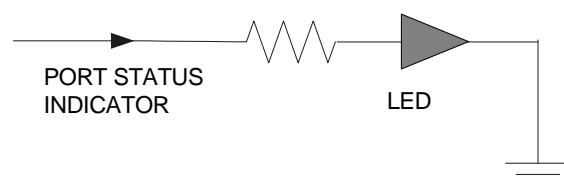
Overcurrent Detection

The OVR#[n] pins of the CY7C65632 series are connected to the respective external power switch's port overcurrent indication (output) signals. After detecting an overcurrent condition, hub reports overcurrent condition to the host and disables the PWR#[n] output to the external power device.

Port Indicators

The USB 2.0 port indicators are also supported directly by CY7C65632. According to the specification, each downstream port of the hub optionally supports a status indicator. The presence of indicators for downstream facing ports is specified by bit 7 of the wHubCharacteristics field of the hub class descriptor. The default CY7C65632 descriptor specifies that the port indicators are supported. The CY7C65632 port indicators has two modes of operation: automatic and manual.

On power up the CY7C65632 defaults to automatic mode, where the color of the Port Indicator (green, amber, off) indicates the functional status of the CY7C65632 port. The LEDs are turned off when the device is suspended



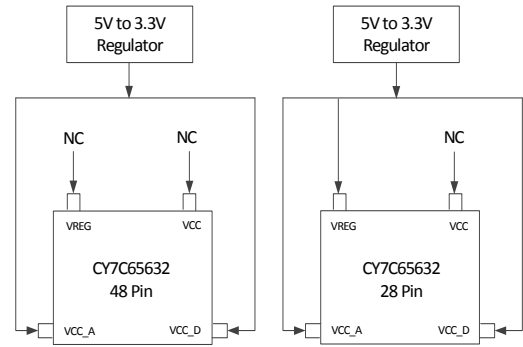
Note Pin-strapping GREEN#[1] and GREEN#[2] enables proprietary function that may affect the normal functionality of HX2VL. Configuring Port #1 and #2 as non-removable by pin-strapping should be avoided.

Power Regulator

CY7C65632 requires 3.3 V source power for normal operation of internal core logic and USB physical layer (PHY). The integrated low-drop power regulator converts 5 V power input from USB cable (Vbus) to 3.3 V source power. The 3.3 V power output is guaranteed by an internal voltage reference circuit when the input voltage is within the 4 V to 5.5 V range. The regulator's maximum current loading is 150 mA, which provides tolerance margin over CY7C65632's normal power consumption of below 100 mA. The on chip regulator has a quiescent current of 28 uA.

External Regulation Scheme

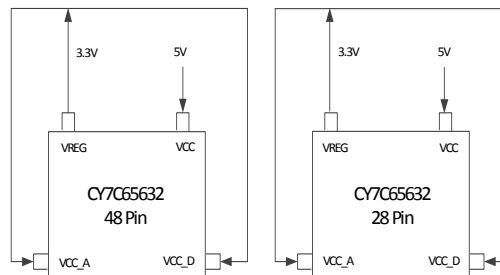
CY7C65632 supports both external regulation and internal regulation schemes. When an external regulation is chosen, then for the 48 Pin package, VCC and VREG are to be left open with no connection. The external regulator output 3.3 V has to be connected to VCC_A and VCC_D pins. This connection has to be done externally, on board. For the 28 Pin package, the 3.3 V output from the external regulator has to be connected to VREG, VCC_A and VCC_D. The VCC pin has to be left open with no connection. From the external input 3.3 V, 1.8 V is internally generated for the chip's internal usage.



External Regulation Scheme

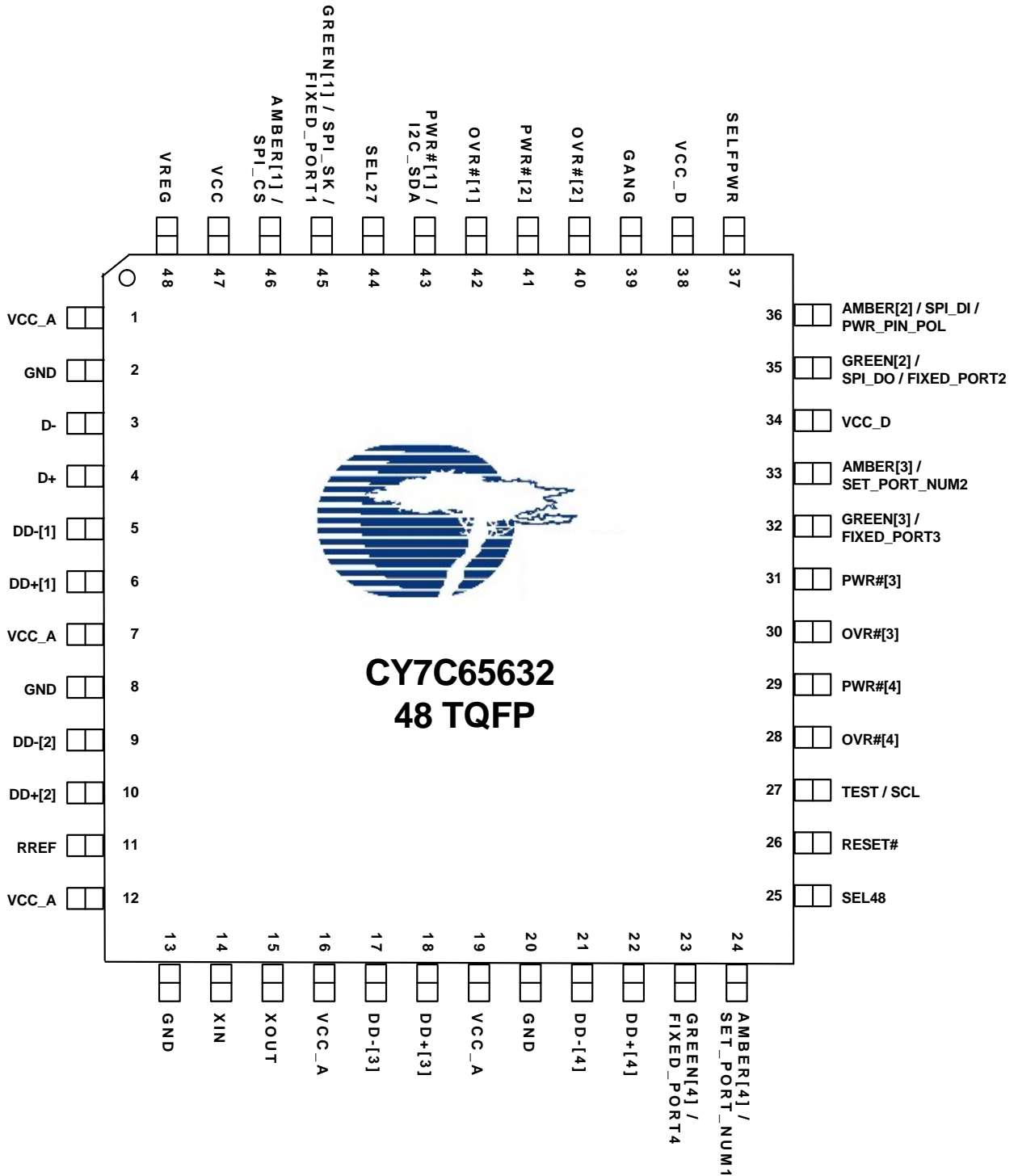
Internal Regulation Scheme

When the built-in internal regulator is chosen, then the VCC pin has to be connected to a 5 V, in both 48 pin and 28 pin packages. Internally, the built-in regulator generates a 3.3 V and 1.8 V for the chip's internal usage. Also a 3.3 V output is available at VREG pin, that has to be connected externally to VCC_A and VCC_D.

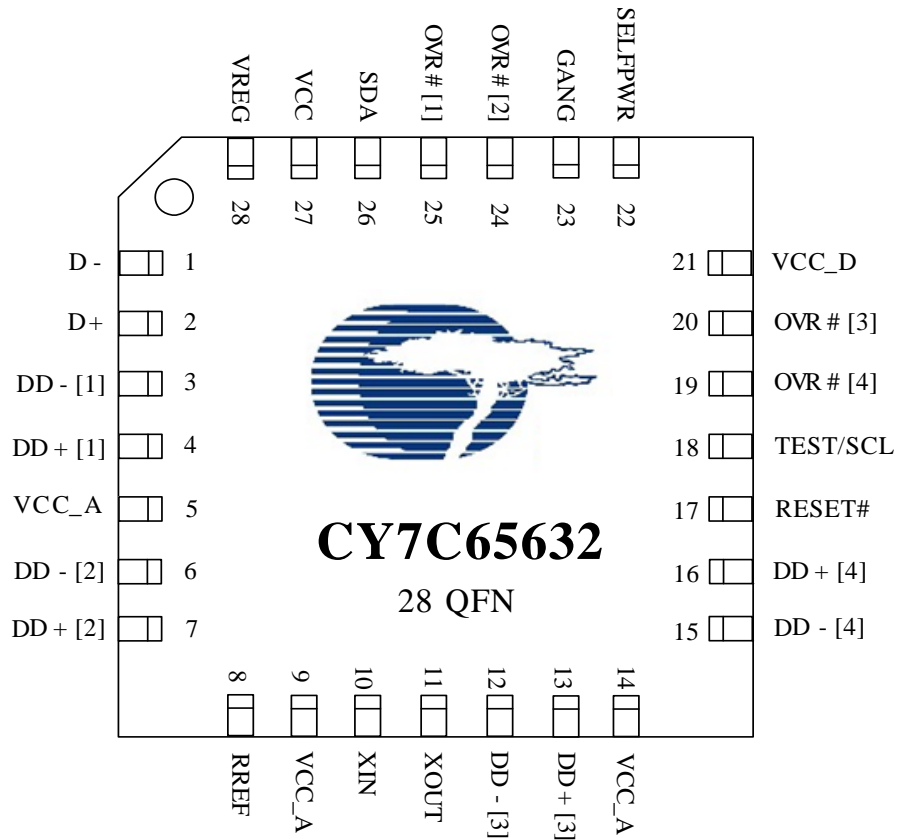


Internal Regulation Scheme

Pin Configuration CY7C65632 – 48 TQFP



Pin Configuration CY7C65632 – 28 QFN



Pin Description for 48-Pin Package

Pin Types: I = Input, O = Output, P = Power/Ground., Z = High Impedance, R_{DN} = Pad internal Pull Down Resistor, R_{UP} = Pad internal Pull Up Resistor.

Table 1. Pin Assignments

Name	48TQFP pin no.	Type	Description
Power and Clock			
VCC_A	1	P	V_{CC_A} . 3.3 V analog power to the chip.
VCC_A	7	P	V_{CC_A} . 3.3 V analog power to the chip.
VCC_A	12	P	V_{CC_A} . 3.3 V analog power to the chip.
VCC_A	16	P	V_{CC_A} . 3.3 V analog power to the chip.
VCC_A	19	P	V_{CC_A} . 3.3 V analog power to the chip.
VCC_D	34	P	V_{CC_D} . 3.3 V digital power to the chip.
VCC_D	38	P	V_{CC_D} . 3.3 V digital power to the chip.
VCC	47	P	V_{CC} . 5 V input to the internal regulator; NC if using external regulator
VREG	48	P	V_{CC} . 5 - 3.3 V regulator o/p during internal regulation; NC if using external regulator.
GND	2	P	GND . Connect to Ground with as short a path as possible.
GND	8	P	GND . Connect to Ground with as short a path as possible.
GND	13	P	GND . Connect to Ground with as short a path as possible.
GND	20	P	GND . Connect to Ground with as short a path as possible.
XIN	14	I	12 MHz crystal clock input, or 12/27/48 MHz clock input
XOUT	15	O	12 MHz Crystal OUT
SEL48/SEL27	25/44	I	00: Reserved 01: 48 MHz OSC-in 10: 27 MHz OSC-in 11: 12 MHz Crystal or OSC-in
RESET#	26	I	Active LOW Reset . External reset input, default pull high 10 K Ohm; When RESET = low, whole chip is reset to the initial state
SELPWR	37	I	Self Power . Input for selecting self/bus power. 0 is bus powered, 1 is self powered.
GANG	39	I/O	GANG Default is input mode after power-on-reset. Gang Mode : Input:1 -> Output is 0 for Normal Operation and 1 for Suspend Individual Mode : Input:0 -> Output is 1 for Normal Operation and 0 for Suspend Refer to Gang/Individual Power Switching Modes in Pin Configuration Options Section for details
RREF	11	I/O	650 ohm resistor must be connected between RREF and Ground
System Interface			
Test I2C_SCL	27	I(R _{DN}) I/O(R _{DN})	Test : 0: Normal Operation & 1: Chip will be put in test mode I2C_SCL : Can be used as I2C clock pin to access I2C EEPROM
Upstream Port			
D-	3	I/O/Z	Upstream D- Signal.
D+	4	I/O/Z	Upstream D+ Signal.
Downstream Port 1			
DD-[1]	5	I/O/Z	Downstream D- Signal.
DD+[1]	6	I/O/Z	Downstream D+ Signal.
AMBER[1] SPI_CS	46	O(R _{DN}) O(R _{DN})	LED . Driver output for Amber LED. Port Indicator Support. Default is Active LOW. SPI_CS . Can be used as chip select to access external SPI EEPROM.

Pin Types: I = Input, O = Output, P = Power/Ground., Z = High Impedance, R_{DN} = Pad internal Pull Down Resistor, R_{UP} = Pad internal Pull Up Resistor.

Table 1. Pin Assignments

Name	48TQFP pin no.	Type	Description
GREEN[1] SPI_SK FIXED_PORT1	45	O(R _{DN}) O(R _{DN}) I(R _{DN})	LED. Driver output for Green LED. Port Indicator Support. Default is Active LOW. SPI_SK. Can be used as SPI Clock to access external SPI EEPROM. FIXED_PORT1. At POR used to set Port1 as non removable port. Refer pin configuration Section
OVR#[1]	42	I(R _{UP})	Overcurrent Condition Detection Input. Default is Active LOW
PWR#[1] I2C_SDA	43	O/Z I/O	Power Switch Driver Output. Default is Active LOW. I2C_SDA. Can be used as I2C Data pin, connected with I2C EEPROM.
Downstream Port 2			
DD-[2]	9	I/O/Z	Downstream D- Signal.
DD+[2]	10	I/O/Z	Downstream D+ Signal.
AMBER[2] SPI_DI PWR_PIN_POL	36	O(R _{DN}) O(R _{DN}) I(R _{DN})	LED. Driver output for Amber LED. Port Indicator Support. Default is Active LOW. SPI_DI. Can be used as Data Out to access external SPI EEPROM. PWR_PIN_POL. Used for power switch enable pin polarity setting. Refer Configuration Section
GREEN[2] SPI_DO FIXED_PORT2	35	O(R _{DN}) I(R _{DN}) I(R _{DN})	LED. Driver output for Green LED. Port Indicator Support. Default is Active LOW. SPI_DO. Can be used as Data In to access external SPI EEPROM. FIXED_PORT2. At POR used to set Port2 as non removable port. Refer Configuration Section
OVR#[2]	40	I(R _{UP})	Overcurrent Condition Detection Input. Default is Active LOW
PWR#[2]	41	O/Z	Power Switch Driver Output. Default is Active LOW
Downstream Port 3			
DD-[3]	17	I/O/Z	Downstream D- Signal.
DD+[3]	18	I/O/Z	Downstream D+ Signal.
AMBER[3] SET_PORT_NUM2	33	O(R _{DN}) I(R _{DN})	LED. Driver output for Amber LED. Port Indicator Support. Default is Active LOW. SET_PORT_NUM2. Used to set port numbering along with SET_PORT_NUM1. Refer pin configuration section.
GREEN[3] FIXED_PORT3	32	O(R _{DN}) I(R _{DN})	LED. Driver output for Green LED. Port Indicator Support. Default is Active LOW. FIXED_PORT3. At POR used to set Port3 as non removable port. Refer pin configuration section.
OVR#[3]	30	I(R _{UP})	Overcurrent Condition Detection Input. Default is Active LOW.
PWR#[3]	31	O/Z	Power Switch Driver Output. Default is Active LOW.
Downstream Port 4			
DD-[4]	21	I/O/Z	Downstream D- Signal.
DD+[4]	22	I/O/Z	Downstream D+ Signal.
AMBER[4] SET_PORT_NUM1	24	O(R _{DN}) I(R _{DN})	LED. Driver output for Amber LED. Port Indicator Support. Default is Active LOW. SET_PORT_NUM1. Used to set port numbering along with SET_PORT_NUM2. Refer configuration Section.
GREEN[4] FIXED_PORT4	23	O(R _{DN}) I(R _{DN})	LED. Driver output for Green LED. Port Indicator Support. Default is Active LOW. FIXED_PORT4. At POR used to set Port4 as non removable port. Refer configuration Section.
OVR#[4]	28	I(R _{UP})	Overcurrent Condition Detection Input. Default is Active LOW.
PWR#[4]	29	O/Z	Power Switch Driver Output. Default is Active LOW.

Pin Description for 28-Pin Package

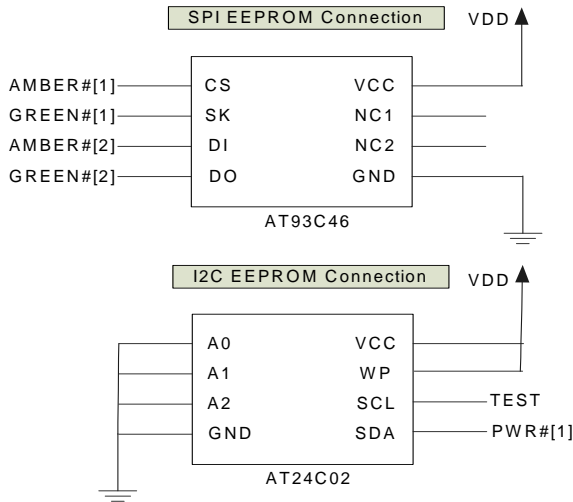
Pin Types: I = Input, O = Output, P = Power/Ground., Z = High Impedance, R_{DN} = Pad internal Pull Down Resistor, R_{UP} = Pad internal Pull Up Resistor.

Table 2. Pin Assignments

Name	28QFN pin no.	Type	Description
Power and Clock			
VCC_A	5	P	V_{CC_A} . 3.3 V analog power to the chip.
VCC_A	9	P	V_{CC_A} . 3.3 V analog power to the chip.
VCC_A	14	P	V_{CC_A} . 3.3 V analog power to the chip.
VCC_D	21	P	V_{CC_D} . 3.3 V digital power to the chip.
VCC	27	P	V_{CC} . 5 V input to the internal regulator; NC if using external regulator
VREG	28	P	V_{CC} . 5 - 3.3 V regulator o/p during internal regulation; 3.3 V i/p if using external regulator.
XIN	10	I	12 MHz crystal clock input, or 12/27/48 MHz clock input
XOUT	11	O	12 MHz Crystal OUT
RESET#	17	I	Active LOW Reset . External reset input, default pull high 10 K Ohm; When RESET = low, whole chip is reset to the initial state
SELPWR	22	I	Self Power . Input for selecting self/bus power. 0 is bus powered, 1 is self powered.
GANG	23	I/O	GANG Default is input mode after power-on-reset. Gang Mode: Input:1 -> Output is 0 for Normal Operation and 1 for Suspend Individual Mode: Input:0 -> Output is 1 for Normal Operation and 0 for Suspend Refer to Gang/Individual Power Switching Modes in Pin Configuration Options Section for details
RREF	8	I/O	650 ohm resistor must be connected between RREF and Ground
System Interface			
Test SCL	18	I(R _{DN}) I/O(R _{DN})	Test: 0: Normal Operation & 1: Chip will be put in test mode SCL: I2C Clock pin.
SDA	26	I/O	SDA: I2C Data pin.
Upstream Port			
D-	1	I/O/Z	Upstream D- Signal.
D+	2	I/O/Z	Upstream D+ Signal.
Downstream Port 1			
DD-[1]	3	I/O/Z	Downstream D- Signal.
DD+[1]	4	I/O/Z	Downstream D+ Signal.
OVR#[1]	25	I(R _{UP})	Overcurrent Condition Detection Input. Default is Active LOW
Downstream Port 2			
DD-[2]	6	I/O/Z	Downstream D- Signal.
DD+[2]	7	I/O/Z	Downstream D+ Signal.
OVR#[2]	24	I(R _{UP})	Overcurrent Condition Detection Input. Default is Active LOW
Downstream Port 3			
DD-[3]	12	I/O/Z	Downstream D- Signal.
DD+[3]	13	I/O/Z	Downstream D+ Signal.
OVR#[3]	20	I(R _{UP})	Overcurrent Condition Detection Input. Default is Active LOW. GND in 2 port parts.
Downstream Port 4			
DD-[4]	15	I/O/Z	Downstream D- Signal.
DD+[4]	16	I/O/Z	Downstream D+ Signal.
OVR#[4]	19	I(R _{UP})	Overcurrent Condition Detection Input. Default is Active LOW. GND in 2 port parts.
GND	PAD	P	Ground pin for the chip. It is the solderable exposed pad beneath the chip. Refer Figure 2 on page 17 .

EEPROM Configuration Options

Systems using CY7C65632 have the option of using the default descriptors to configure the hub. Otherwise, it must have an external EEPROM for the device to have a unique VID, and PID. The CY7C65632 can communicate with an SPI (microwire) EEPROM like 93C46 or I2C EEPROM like 24C02. Example EEPROM connections are as shown in the following figure.



Note The 28 pin QFN package includes only support for I2C EEPROM like ATMEL/24C02N_SU27 D, MICROCHIP/4LC028 SN0509, SEIKO/S24CS02AVH9. The 48 pin TQFP package includes both I2C and SPI EEPROM connectivity options. In this case, user can use either SPI or I2C connectivity at a time for communicating to EEPROM. The 48 pin package supports ATMEL/AT93C46DN-SH-T, in addition to the above mentioned families. HX2VL can only read from SPI EEPROM. So, field programming of EEPROM is supported only for I2C EEPROM. CY7C65632 verifies the check sum after power on reset and if validated loads the configuration from the EEPROM. To prevent this configuration from being overwritten, amber LED is disabled

when SPI EEPROM is present. Default VID is 0x4B4, PID is

Byte	Value
00h	VID_LSB
01h	VID_MSB
02h	PID_LSB
03h	PID_MSB
04h	ChkSum
05h	Reserved - FE
06h	Removable Ports
07h	Port Number
08h	Maximum Power
09h - 0Fh	Reserved - FF (except 0Bh which is FE)
10h	Vendor String Length
11h - 3Fh	Vendor String (ASCII code)
40h	Product String Length
41h - 6Fh	Product String (ASCII Code)
70h	Serial Number Length
71h to 80h onwards	Serial Number String

0x6570.

Byte 0: VID (LSB)

Least Significant Byte of Vendor ID

Byte 1: VID (MSB)

Most Significant Byte of Vendor ID

Byte2: PID (LSB)

Least Significant Byte of Product ID

Byte 3: PID (MSB)]

Most Significant Byte of Product ID

Byte 4: ChkSum

CY7C65632 will ignore the EEPROM settings if ChkSum is not equal to VID_LSB + VID_MSB + PID_LSB + PID_MSB + 1

Byte 5: Reserved

Set to FF

Byte 6: RemovablePorts

RemovablePorts[4:1] are the bits that indicates whether the device attached to the corresponding downstream port is removable (set to 0). Bit 1 corresponds to Port 1, Bit 2 to Port 2 and so on. These bit values are reported appropriately in the HubDescriptor:DeviceRemovable field.

Bits 0,5,6,7 are set to 0.

Byte 7: Port Number

Port Number values must be 1 to 4

Byte 8: Maximum Power

This value is reported in the Configuration Descriptor: bMax-Power field and is the current in 2 mA increments that is required from the upstream hubs. The allowed range is 00h (0 mA) to FAh(500 mA)

Byte 9 - 15: Reserved

Set to FF

Byte 16: Vendor String Length

Length of the Vendor String

Byte 17 - 63: Vendor String

Value of Vendor String.

Strings must comply with the USB specification. The first byte (Byte 16) must be the length of the string in bytes, the second must be 0x03, and the string must be in ASCII code.

Byte 64: Product String Length

Length of the Product String

Byte 65- 111: Product String

Value of Product String in ASCII code

Byte 112: Serial Number Length

Length of the Serial Number

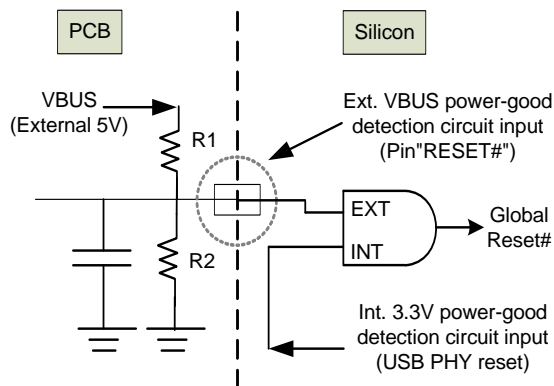
Byte 113 onwards: Serial Number String

Serial Number String in ASCII code.

Pin Configuration Options

Power-on Reset

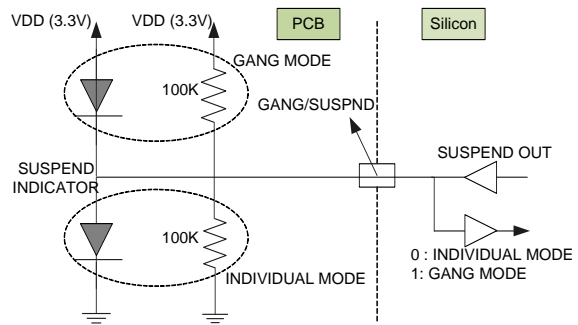
The power on reset can be triggered by external reset or internal circuitry. The internal reset is initiated, when there is an unstable power event for silicon's internal core power (3.3 V). The internal reset is released after approximately 2.7 micro-seconds of stable internal core voltage. The external reset pin, continuously senses the voltage level (5 V) on the upstream VBUS as shown in the figure. In the event of USB plug/unplug or drop in voltage, the external reset is triggered. This reset trigger can be configured using the resistors R1 and R2. Cypress recommends that the reset time applied in external reset circuit should be longer than that of the internal reset time.



Gang/Individual Power Switching Mode

A single pin is used to set individual / gang mode as well as output the suspend flag. This is done to reduce the pin count.

The individual or gang mode is decided within 20 us after power on reset. 50ms after reset, this pin is changed to output mode. CY7C65632 outputs the suspend flag, after it is globally suspended. Pull-down resistor of greater than 100 K is needed for Individual mode and a pull-up resistor greater than 100 K is needed for Gang mode. Figure below shows the suspend LED indicator schematics. The polarity of LED must be followed, otherwise the suspend current will be over the spec limitation (2.5 mA).



Features Supported in 48-pin and 28-pin Packages

Supported Features	48 Pin	28 Pin
Port number configuration	Yes	No
Non-Removable port configuration	Yes	No
Reference clock configuration	Yes	No
Power switch enable polarity	Yes	No
LED Indicator	Yes	No

Power Switch Enable Pin Polarity

The pin polarity is set Active-High by pin-strapping the PWR_PIN_POL pin to 1 and Active-Low by pin-strapping the PWR_PIN_POL pin to 0. Thus, both kinds of power switches are supported. This feature is not supported in QFN-28 package.

Port Number Configuration

In addition to the EEPROM configuration, as described above, configuring the hub for 2/3/4 ports is also supported using pin-strapping SET_PORT_NUM1 and SET_PORT_NUM2, as shown in following table. Pin strapping option is not supported in the 28-QFN package.

SET_PORT_NUM2	SET_PORT_NUM1	# Ports
1	1	1 (Port 1)
1	0	2 (Port 1/2)
0	1	3 (Port 1/2/3)
0	0	4 (All ports)

Non Removable Ports Configuration

In embedded systems, downstream ports that are always connected inside the system, can be set as non-removable (always connected) ports, by pin-strapping the corresponding FIXED_PORT# pins 1~4 to High, before power on reset. At POR, if the pin is pull high, the corresponding port is set to non-removable. This is not supported in the 28-QFN package.

Reference Clock Configuration

This hub can support, optional 27/48 MHz clock source. When on-board 27/48 MHz clock is present, then using this feature, system integrator can further reduce the BOM cost by eliminating the external crystal. This is available through GPIO pin configuration shown as follows. This is not supported in the 28-QFN package

SEL48	SEL27	Clock Source
0	1	48 MHz OSC-in
1	0	27 MHz OSC-in
1	1	12 MHz X'tal/OSC-in

Electrical Characteristics

Absolute Maximum Ratings

Exceeding maximum ratings may shorten the useful life of the device. User guidelines are not tested.

Storage Temperature -55 °C to +100 °C
 Ambient Temperature 0 °C to +70 °C
 5 V Supply Voltage to Ground Potential -0.5 V to +6.0 V
 3.3 V Supply Voltage to Ground Potential ... -0.5 V to +3.6 V
 Voltage at Open Drain Input Pins (OVR#1-4, SELFPWR, RESET#) -0.5 V to +5.5 V
 3.3 V Input Voltage for digital I/O -0.5 V to +3.6 V
 FOSC (Oscillator or Crystal Frequency) 12 MHz ± 0.05%

Operating Conditions

Ambient Temperature 0°C to +70 °C
 Ambient Max Junction Temperature 0°C to +125 °C
 5 V Supply Voltage to Ground Potential 4.75 V to +5.25 V
 3.3 V Supply Voltage to Ground Potential ... 3.15 V to +3.6 V
 Input Voltage for USB signal pins 0.5 V to +3.6 V
 Voltage at Open Drain Input Pins -0.5 V to +5.0 V
 Thermal Characteristics 48 TQFP 75.8 °C/W
 Thermal Characteristics 28 QFN 32.4 °C/W

Table 3. DC Electrical Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
P _D	Power Dissipation	Excluding USB signals	366.5		426.5	mW
V _{IH}	Input High Voltage		2			V
V _{IL}	Input Low Voltage				0.8	V
I _I	Input Leakage Current	Full Speed/ Low Speed (0 < V _{IN} < V _{CC})	-10		+10	µA
		High Speed mode (0 < V _{IN} < V _{CC})	-5	0	+5	µA
V _{OH}	Output Voltage High	I _{OH} = 8 mA	2.4			V
V _{OL}	Output Low Voltage	I _{OL} = 8 mA			0.4	V
R _{DN}	Pad internal pull-down Resistor		29	59	135	KOhm
R _{UP}	Pad internal pull-up Resistor		80	108	140	KOhm
C _{IN}	Input Pin Capacitance	Full Speed / Low Speed mode			20	pF
		High Speed mode	4	4.5	5	pF
I _{SUSP}	Suspend Current			786	903	µA
I _{CC}	Supply Current					
	4 Active Ports	Full Speed Host, Full Speed Devices		88.7	99.78	mA
		High Speed Host, High Speed Devices		81.9	91.44	mA
		High Speed Host, Full Speed Devices		88.2	97.23	mA
	3 Active Ports	Full Speed Host, Full Speed Devices		79.1	94.6	mA
		High Speed Host, High Speed Devices		72.9	80.92	mA
		High Speed Host, Full Speed Devices		75.9	92.02	mA
	2 Active Ports	Full Speed Host, Full Speed Devices		68.1	80.53	mA
		High Speed Host, High Speed Devices		61.9	70.55	mA
		High Speed Host, Full Speed Devices		64.9	77.46	mA
	1 Active Ports	Full Speed Host, Full Speed Devices		57.1	66.66	mA
		High Speed Host, High Speed Devices		51.9	60.32	mA
		High Speed Host, Full Speed Devices		54.7	63.81	mA
	No Active Ports	Full Speed Host		42.8	49.02	mA
High Speed Host			44.2	49.78	mA	

USB Transceiver is USB 2.0 certified in low, full and high speed modes.

AC Electrical Characteristics

Both the upstream USB transceiver and all four downstream transceivers have passed the USB-IF USB 2.0 Electrical Certification Testing.

The 48 pin TQFP package can support communication to EEPROM using either I²C or SPI. The 28-pin QFN package can support only I²C communication to EEPROM. AC characteristics of these two interfaces to EEPROM are summarized in tables below:

Table 4. AC characteristics of SPI EEPROM interface

Symbol	Parameter	Min	Typ	Max	Units
t _{CSS}	CS Setup Time	3.0			us
t _{CSH}	CS Hold Time	3.0			
t _{SKH}	SK High Time	1.0			
t _{SKL}	SK Low Time	2.2			
t _{DIS}	DI Setup Time	1.8			
t _{DIH}	DI Hold Time	2.4			
t _{PD1}	Output Delay to '1'			1.8	
t _{PD0}	Output Delay to '0'			1.8	

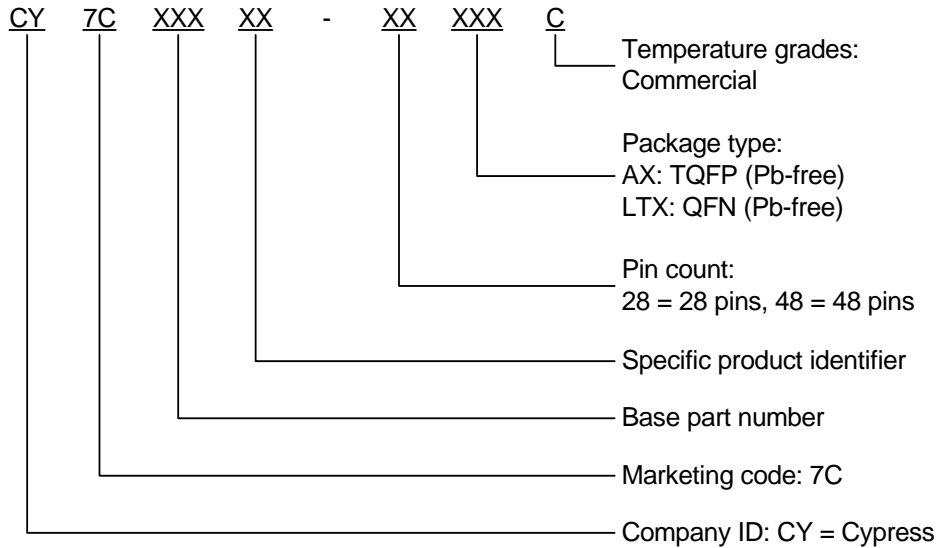
Table 5. AC characteristics of I2C EEPROM interface

Symbol	Parameter	1.8V - 5.5V		2.5V - 5.5V		Units
		Min	Max	Min	Max	
f _{SCL}	SCL Clock Frequency	0.0	100	0.0	400	KHz
t _{LOW}	Clock LOW Period	4.7	-	1.2	-	us
t _{HIGH}	Clock HIGH Period	4.0	-	0.6	-	us
t _{SU:STA}	Start Condition Setup Time	4.7	-	0.6	-	us
t _{SU:STO}	Stop Condition Setup Time	4.7	-	0.6	-	us
t _{HD:STA}	Start Condition Hold Time	4.0	-	0.6	-	us
t _{HD:STO}	Stop Condition Hold Time	4.0	-	0.6	-	us
t _{SU:DAT}	Data In Setup Time	200.0	-	100.0	-	ns
t _{HD:DAT}	Data In Hold Time	0	-	0	-	ns
t _{DH}	Data Out Hold Time	100	-	50	-	ns
t _{AA}	Clock to Output	0.1	4.5	0.1	0.9	us

Ordering Information

Ordering Code	Device	Package Type
CY7C65632-48AXC	4 port Single-TT hub (configurable with GPIOs and EEPROM)	48-Pin TQFP Bulk
CY7C65632-28LTXC	4 port Single-TT hub (configurable with GPIOs and EEPROM)	28-Pin QFN Bulk

Ordering Code Definitions



Package Diagrams

The CY7C65632 is available in following packages:

Figure 1. 48-Pin TQFP Package Diagram

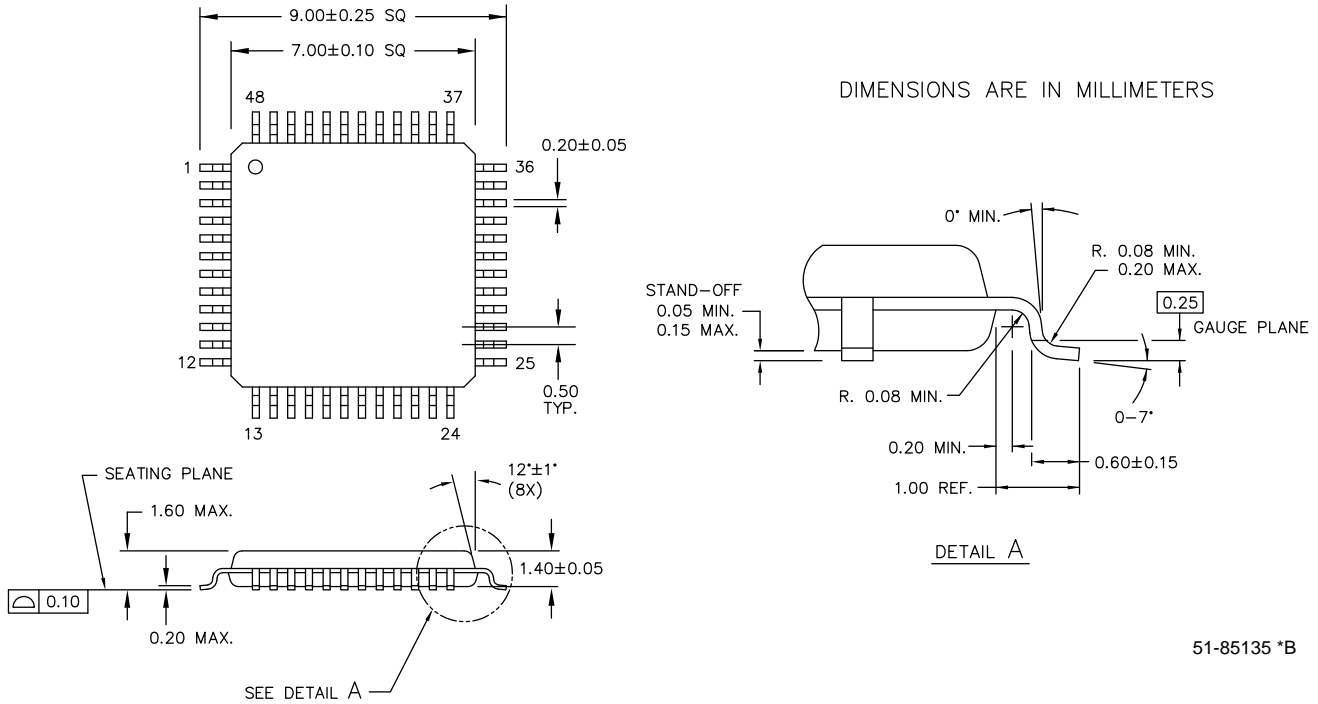
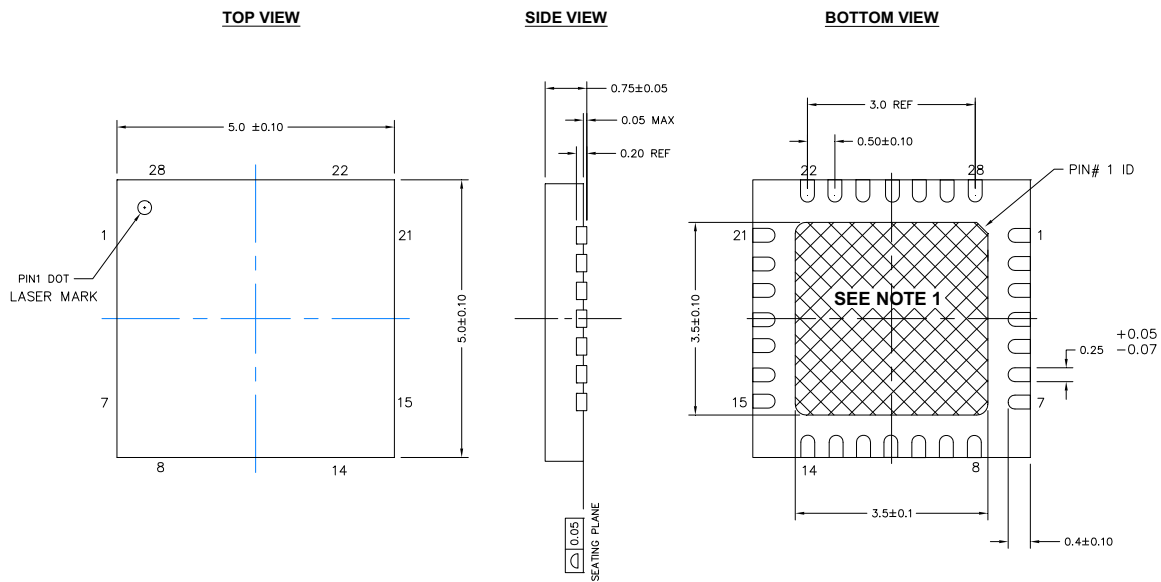



Figure 2. 28-Pin QFN Package Diagram



NOTES:

1.  HATCH AREA IS SOLDERABLE EXPOSED PAD
2. BASED ON REF JEDEC # MO-220
3. PACKAGE WEIGHT: ~0.05gr
4. DIMENSIONS ARE IN MILLIMETERS

001-64621 **

Acronyms

The following table lists the acronyms that are used in this document.

Table 6. Acronyms Used in this Datasheet

Acronym	Description	Acronym	Description
AC	alternating current	PC	program counter
ADC	analog-to-digital converter	PLL	phase-locked loop
API	application programming interface	POR	power on reset
CPU	central processing unit	PPOR	precision power on reset
CT	continuous time	PSoC®	Programmable System-on-Chip™
ECO	external crystal oscillator	PWM	pulse width modulator
EEPROM	electrically erasable programmable read-only memory	SC	switched capacitor
FSR	full scale range	SRAM	static random access memory
GPIO	general purpose I/O	ICE	in-circuit emulator
GUI	graphical user interface	ILO	internal low speed oscillator
HBM	human body model	IMO	internal main oscillator
LSb	least-significant bit	I/O	input/output
LVD	low voltage detect	IPOR	imprecise power on reset
MSb	most-significant bit		

Document Conventions

Units of Measure

The following table lists the units of measure that are used in this document.

Table 7. Units of Measure

Symbol	Unit of Measure	Symbol	Unit of Measure
°C	degree Celsius	μW	microwatts
dB	decibels	mA	milliampere
fF	femto farad	ms	millisecond
Hz	hertz	mV	millivolts
KB	1024 bytes	nA	nanoampere
Kbit	1024 bits	ns	nanosecond
kHz	kilohertz	nV	nanovolts
kΩ	kilohm	Ω	ohm
MHz	megahertz	pA	picoampere
MΩ	megaohm	pF	picofarad
μA	microampere	pp	peak-to-peak
μF	microfarad	ppm	parts per million
μH	microhenry	ps	picosecond
μs	microsecond	sps	samples per second
μV	microvolts	s	sigma: one standard deviation
μVrms	microvolts root-mean-square	V	volts

Document History Page

Document Title: CY7C65632 HX2VL™ Very Low Power USB 2.0 Hub Controller Document Number: 001-67568				
Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	3183649	SSJO/ SWAK	03/02/2011	New datasheet
*A	3250883	SWAK/AASI	06/30/2011	<ol style="list-style-type: none"> 1. In page 6, the pin of the 48-pin TQFP package was named SELF_PWR. It is changed to SELFPWR. 2. In page 9, 10 and 11 the entry against OVR# in the pin assignment table is changed to "Active LOW Overcurrent Condition Detection Input" as it should not say "Default is Active LOW" since the polarity is not configurable. 3. In page 8 and 11, in page assignment table, entry against XOUT is changed to "12-MHz Crystal OUT. (NC if external clock is used)" 4. In page 11, under pin assignment table, entry against XIN is changed to "12-MHz crystal clock input, or 12-MHz clock input" since 28-pin package does not support 27 and 48 MHz. 5. In page 4, under "Port indicators" section added the following as a note "pin-strapping GREEN#[1] and GREEN#[2] enables proprietary function that may affect the normal functionality of HX2VL. Configuring Port #1 and #2 as non-removable by pin-strapping should be avoided". 6. Added note # 1 on page 9 and is referred to GREEN#[1] and GREEN#[2] under "Pin Description for 48-Pin TQFP Package" on page 8. 7. In section "Power Switch Enable Pin Polarity" on page 13 replaced first two occurrences of the word "setting" with "pin-strapping".

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